506864882 09/13/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6911704

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YI-FAN LIOU	09/06/2021
YEN-CHUN HUANG	09/06/2021

RECEIVING PARTY DATA

Name:	CORETRONIC CORPORATION	
Street Address:	NO. 11, LI-HSIN RD., HSINCHU SCIENCE PARK,	
City:	HSIN-CHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17467453

CORRESPONDENCE DATA

Fax Number: (949)391-4699

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 886223692800
Email: usa@jcipgroup.com

Correspondent Name: JCIPRNET

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ATTORNEY DOCKET NUMBER:	096112-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	09/13/2021

Total Attachments: 2

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PATENT 506864882 REEL: 057456 FRAME: 0384

ASSIGNMENT

WHEREAS,

1.Yi-Fan Liou

2.Yen-Chun Huang

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ELECTRONIC DEVICE AND METHOD FOR TRAINING OR APPLYING NEURAL NETWORK MODEL

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, 1. Coretronic Corporation
of No. 11, Li-Hsin Rd., Hsinchu Science Park, Hsin-Chu 300,
Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have assigned and transferred, and by these presents does/do assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Yi Fan Liovi Date: Sept. 06, 2021

Sole or First Joint Inventor: Yi-Fan Liou

Signature: Jen-Chun Huang Date: Sept. 06, 2021

Second Joint Inventor (if any): Yen-Chun Huang